

# DATA SHEET

PART NO.: LT1808WDT-CW-S60

REV: A/0

CUSTOMER'S APPROVAL: \_\_\_\_\_

DCC: \_\_\_\_\_

DRAWING NO.: DS-31P-22-0099

DATE: 2022-08-22

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LD-R/R005

# SURFACE MOUNT DEVICE LED

LT1808WDT-CW-S60

REV: A/0

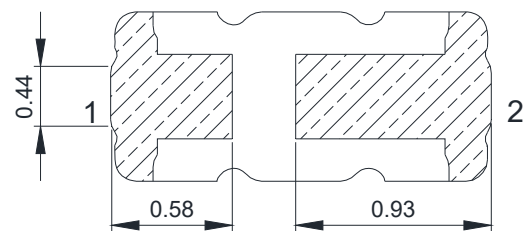
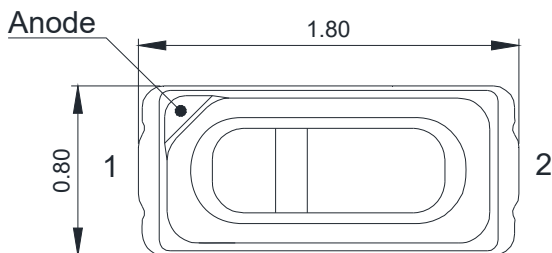
## ● Features

- Low power consumption.
- Suitable for all SMT assembly and solder process.
- High Luminous Intensity and high efficiency
- Moisture sensitivity level: Level 5a.
- Available on tape and reel.
- RoHS compliant.
- Pb-free.

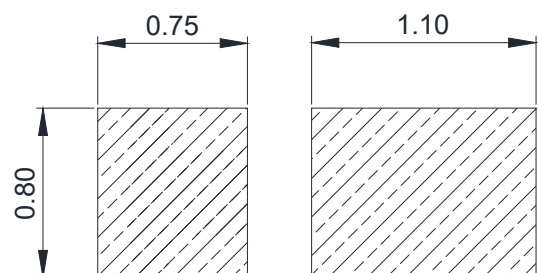
## ● Applications

- Indoor Lighting.
- Backlighting.
- Indicators, Consumer, Industrial, Electronics.

## ● Package Dimensions



Recommended pad size



## Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.254\text{mm}$  (0.01") unless otherwise specified.
3. Lead spacing is measured where the leads emerge from the package.
4. Specifications are subject to change with notice.

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## ● Selection Guide

Dice	Lens Type	Luminous Intensity(mcd)@20mA			Viewing Angle 2θ1/2
		Min.	Typ.	Max.	
White (InGaN)	Yellow Diffused	1500	-	3000	120°

## ● Electrical and optical characteristics(Ta=25°C)

Items	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF=20mA	2.8	-	3.1	V
Reverse Current	IR	VR =5V	-	-	5	uA
Chromaticity Coordinates	X	IF=20mA	-	0.31	-	-
Chromaticity Coordinates	Y	IF=20mA	-	0.34	-	-
Color rendering index	CRI	IF=20mA	80	-	-	Ra

## ● Absolute Maximum Ratings At Ta=25°C

Items	Symbol	Rating	Unit
Forward Current	IF	30	mA
Peak Forward Current	IFP	10	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	100	mW
ESD(Human Body Model)	HBM	2000	V
Operating Temperature Range	Topr	-40°C ~ + 85°C	
Storage Temperature Range	Tstg	-40°C ~ +100°C	
Lead Soldering Temperature	Tsol	Reflow soldering : 260°C For 10 Seconds Hand soldering: 300°C For 3 Seconds	

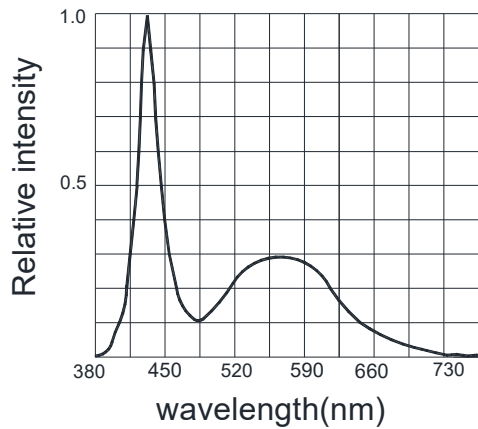
# SURFACE MOUNT DEVICE LED

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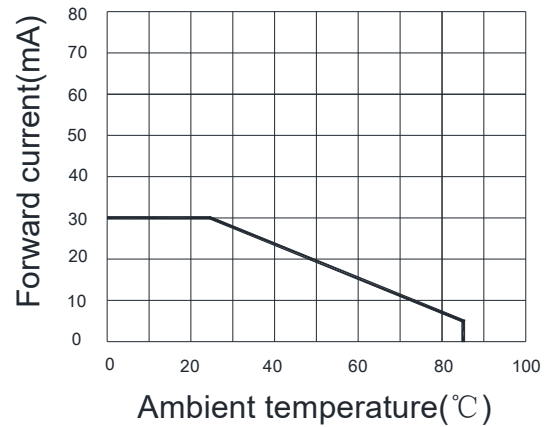
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## ● Typical electro-optical characteristics curves

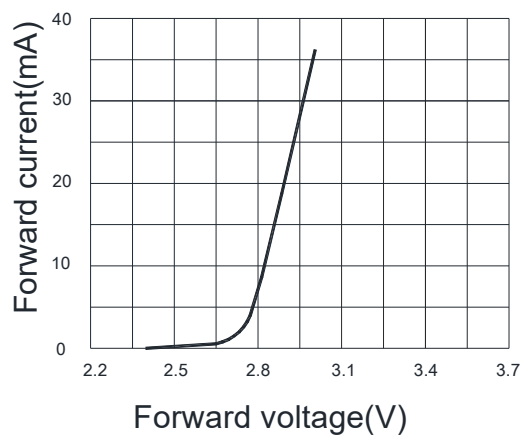
Relative intensity VS wavelength



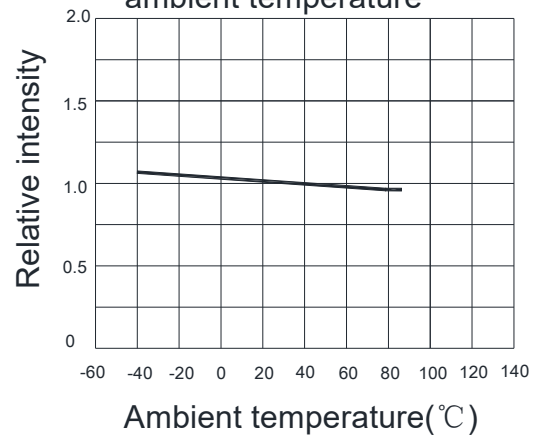
Current and ambient temperature



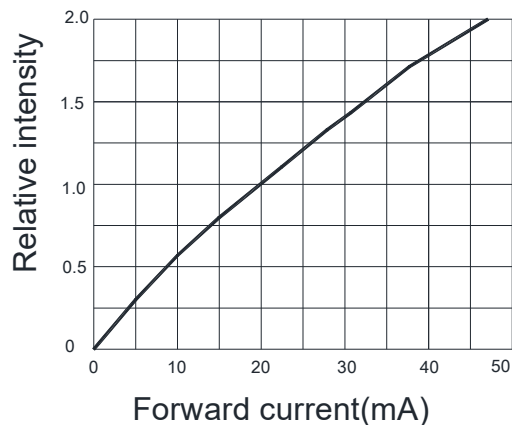
Voltage current relationship



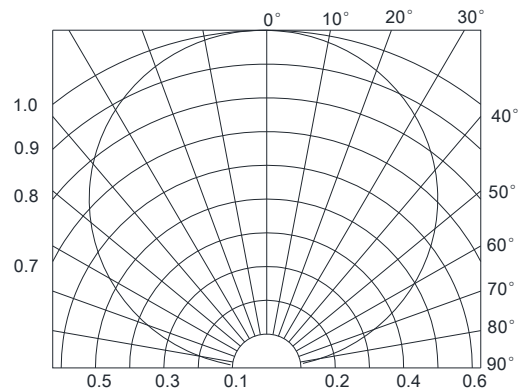
Relative light intensity vs ambient temperature



Relative light intensity vs current



Radiation angle



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## ●Bin Code List

Forward Voltage(VF) @IF=20mA			Unit: v
Bin Code	Min.	Max.	
-	2.8	2.9	
-	2.9	3.0	
-	3.0	3.1	

Note: Tolerance for each Forward Voltage Bin is  $\pm 0.05V$ .

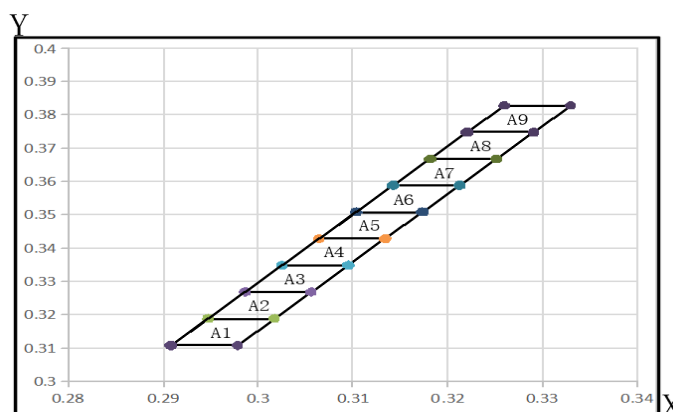
Luminous Intensity(lv) @IF=20mA			Unit: mcd
Bin Code	Min.	Max.	
-	2000	1500	
-	3000	2000	

Note: Tolerance for each Luminous Intensity Bin is  $\pm 10\%$ .

## ●Color Bins

CODE	X1	Y1	X2	Y2	X3	Y3	X4	Y4
A1	0.2908	0.3109	0.2947	0.3189	0.3017	0.3189	0.2978	0.3109
A2	0.2947	0.3189	0.2986	0.3269	0.3056	0.3269	0.3017	0.3189
A3	0.2986	0.3269	0.3025	0.3349	0.3095	0.3349	0.3056	0.3269
A4	0.3025	0.3349	0.3064	0.3429	0.3134	0.3429	0.3095	0.3349
A5	0.3064	0.3429	0.3103	0.3509	0.3173	0.3509	0.3134	0.3429
A6	0.3103	0.3509	0.3142	0.3589	0.3212	0.3589	0.3173	0.3509
A7	0.3142	0.3589	0.3181	0.3669	0.3251	0.3669	0.3212	0.3589
A8	0.3181	0.3669	0.322	0.3749	0.329	0.3749	0.3251	0.3669
A9	0.322	0.3749	0.3259	0.3829	0.3329	0.3829	0.329	0.3749

Note: Tolerance of measurement of Chromatic coordinates is  $\pm 0.005$

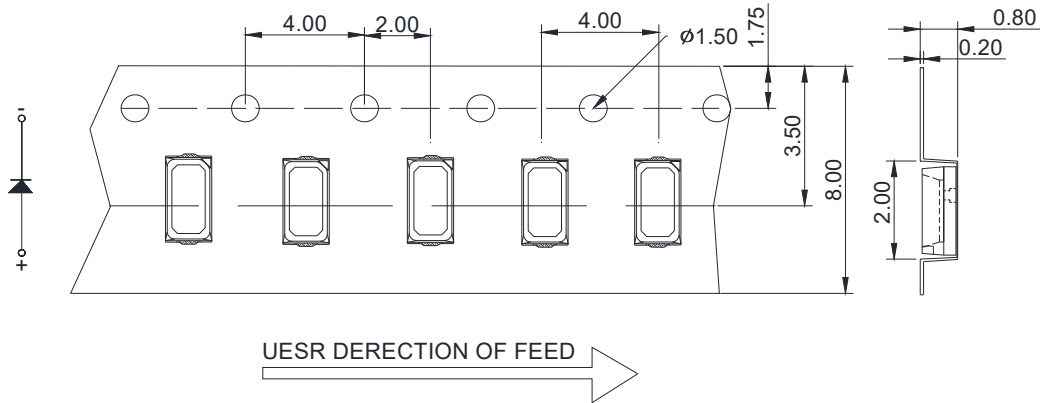


# SURFACE MOUNT DEVICE LED

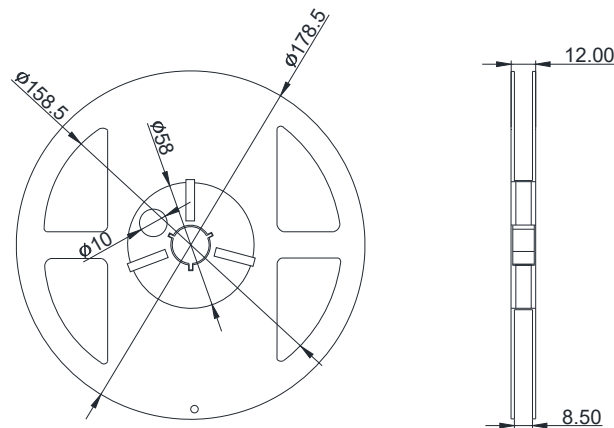
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## ●Packaging

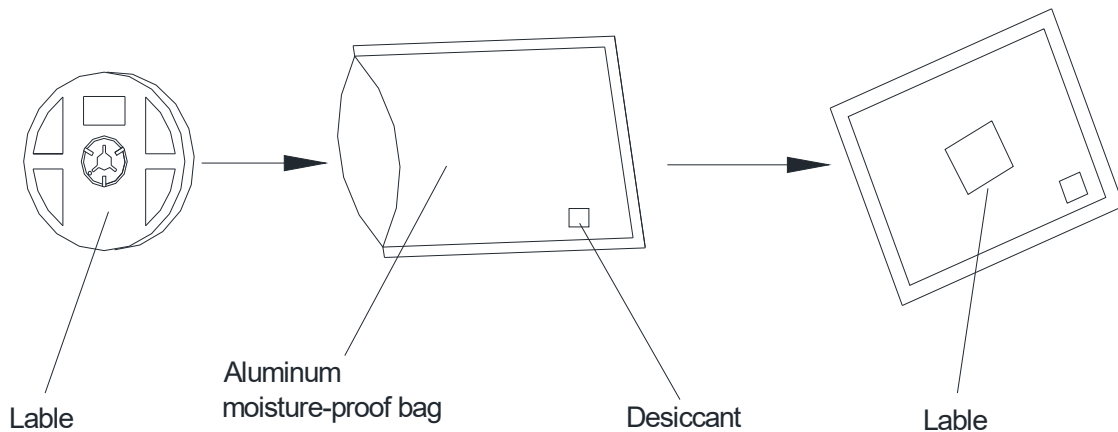


Note: Tolerance unless mentioned is  $\pm 0.1$ mm; Unit = mm



Carrier Tape Dimensions: Loaded Quantity 5000 pcs Per Reel.

## ●Moisture Resistant Packaging



# SURFACE MOUNT DEVICE LED

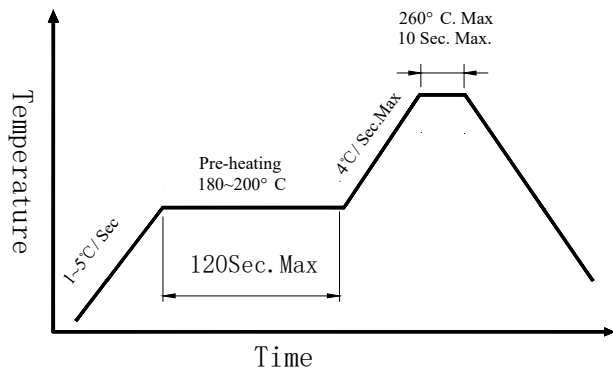
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REV: A/0

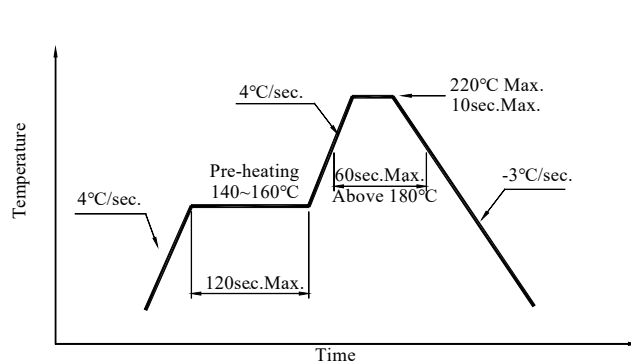
## ●Precautions for Use

### • SMT Reflow Soldering Instructions

< Pb-free solder >



<Lead solder >



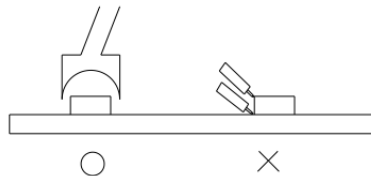
- 1.Reflow soldering should not be done more than two times
- 2.When soldering, do not put stress on the LEDs during heating

### • Soldering Iron

1. When hand soldering, keep the temperature of iron below less 300°C less than 3 seconds.
2. The hand solder should be done only one time.

### • Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure).It should be confirmed in advance whether the characteristics of LEDs will or will not be damaged by repairing.



## ●Cautions

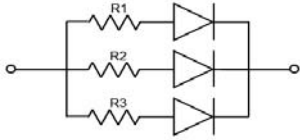
### Application

- 1.A LED is a current-operated device. The slight shift of voltage will cause big change of current, which will damage LEDs. Customer should use resistors in series for the Over-Current-Proof.
- 2.In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended to use individual resistor separately, as shown in Circuit A below.  
The brightness of each LED shown in Circuit B might appear difference due to the differences in the I-V characteristics of those LEDs.

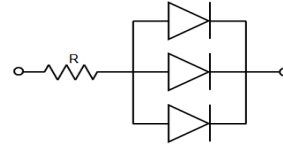
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**Circuit model A**



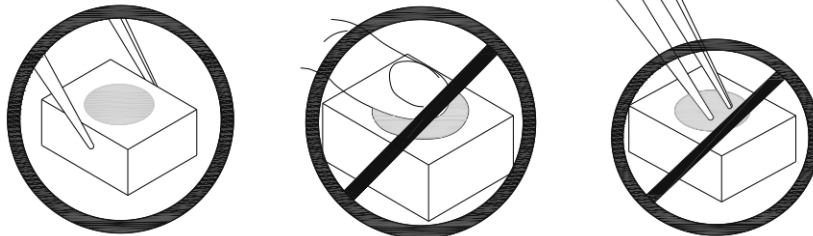
**Circuit model B**

High temperature may reduce LEDs' intensity and other performances, so keeping it away from heat source to get good performance is necessary.

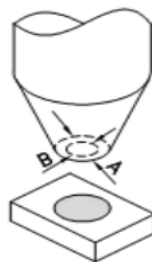
## Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more prone to damage by external mechanical force. As a result, special handling precautions must be observed during assembling using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

1. Handle the component along the side surface by using forceps or appropriate tools, do not directly touch or handle the silicone lens surface, it may damage the internal circuitry.



2. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup. The dimensions of the component must be accurately programmed in the pick-and- place machine to insure precise pickup and avoid damage during production.

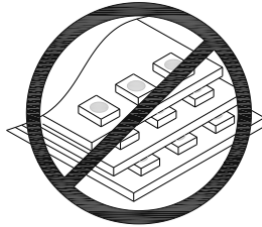


3. Do not stack together assembled PCBs containing LEDs. Impact may scratch the silicon lens or damage the internal circuitry.

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4. Not suitable to operate in acidic environment, PH<7.



## Storage

1. Before opening the original package, it is recommended to store it in the following environment: temperature: 5 °C ~ 30 °C / humidity: maximum relative humidity: 60%.
2. After opening original package, the storage ambient for the LEDs should be in 5~30°C temperature and 60% or less relative humidity.
3. In order to avoid moisture absorption, it is recommended that the LEDs that out of the original package should be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.
4. The LEDs should be used within 24hrs (1 day) after opening the package. Once been mounted, soldering should be quick.
5. If the moisture absorbent material (silica gel) has faded away or the LEDs stored out of original package for more than 168hrs (7 days), baking treatment should be performed using the conditions: 65°C at least 48 hours.
6. Less than three months of the products must be baked at 65±5°C/48 hours after opening package before they can be produced.
7. More than three months of the products must be returned to our company for high temperature baking at 150°C/4 hours.

## ESD (Electrostatic Discharge )-Protection

A LED (especially the Blue White and Green product) is an ESD sensitive component, and static electricity or power surge will damage the LED. ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or “no light-up” at low currents, etc.

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## **Some advice as below should be noticed:**

1. A conductive wrist strap or anti-electrostatic glove should be worn when handling these LEDs.
2. All devices, equipment, machinery, work tables and storage racks, etc. must be properly grounded.
3. Use anti-static package or boxes to carry and storage LEDs. And ordinary plastic package or boxes is forbidden to use.
4. Use ionizer to neutralize the static charge during handling or operating.
5. All surfaces and objects within 1 ft close to LEDs measure less than 100V.

## **Cleaning**

Use alcohol-based cleaning solvents such as IPA (isopropyl alcohol) to clean LEDs if necessary.

## **Others**

1. The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult light's Sales in advance for the applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health. ( such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).
2. The light output from the high luminous intensity LEDs may cause injury to human eyes when viewed directly.
3. The appearance and specifications of the product may be modified for improvement without prior notice.